



**CHENMKO ENTERPRISE CO.,LTD**

*Halogens free devices*

**SURFACE MOUNT  
General Purpose Transistor**

VOLTAGE 25 Volts CURRENT 200 mAmpere

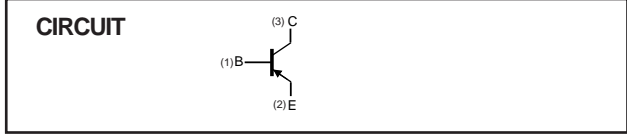
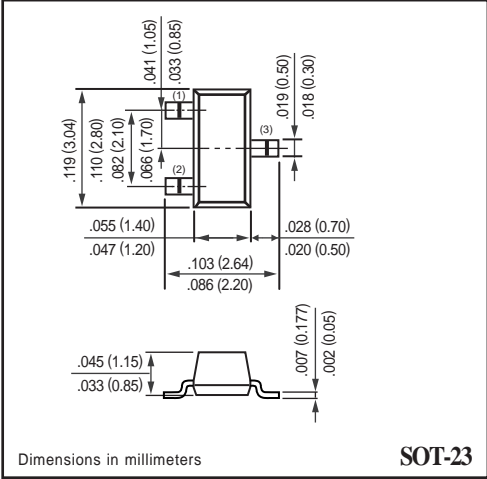
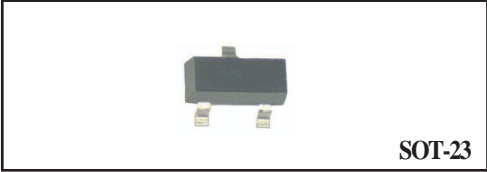
**CHT4126GP**

**APPLICATION**  
 \* AF input stages and driver applicationon equipment.  
 \* Other general purpose applications.

**FEATURE**  
 \* Surface mount package. (SOT-23)  
 \* High current gain.  
 \* Suitable for high packing density.  
 \* Low collector-emitter saturation.  
 \* High saturation current capability.

**CONSTRUCTION**  
 \* PNP Silicon Transistor

**MARKING**  
 \* QT



**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	-	-25	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-25	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	-4	V
I <sub>C</sub>	collector current (DC)		-	-200	mA
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 2	-	350	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature		-	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

**Note**

2. Transistor mounted on an FR4 printed-circuit board.

## RATING CHARACTERISTIC CURVES ( CHT4126GP )

### CHARACTERISTICS

$T_{amb} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{(BR)CBO}$	collector-base breakdown voltage	$I_C = -10\mu\text{A}$ ; $I_E = 0\text{A}$	-25	–	V
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = -1\text{mA}$ ; $I_B = 0\text{A}$	-25	–	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_E = -10\mu\text{A}$ ; $I_C = 0\text{A}$	-4	–	V
$I_{CBO}$	collector cut-off current	$I_E = 0$ ; $V_{CB} = -20\text{ V}$	–	-50	nA
$I_{EBO}$	emitter cut-off current	$I_C = 0$ ; $V_{EB} = -3\text{ V}$	–	-50	nA
$h_{FE}$	DC current gain	$I_C = -50\text{ mA}$ ; $V_{CE} = -1\text{V}$ ; note 3	60	–	
$h_{FE}$	DC current gain	$I_C = -2\text{ mA}$ ; $V_{CE} = -1\text{V}$	120	360	
$V_{CEsat}$	collector-emitter saturation	$I_C = -50\text{ mA}$ ; $I_B = -5\text{ mA}$	–	-400	mV
$V_{BEsat}$	base-emitter saturation voltage	$I_C = -50\text{ mA}$ ; $I_B = -5\text{ mA}$	–	-950	mV
$C_{obo}$	output capacitance	$I_E = i_e = 0$ ; $V_{CB} = -5\text{ V}$ ; $f = 1\text{ MHz}$	–	4.5	pF
$C_{ibo}$	input capacitance	$I_E = i_e = 0$ ; $V_{CB} = -5\text{ V}$ ; $f = 1\text{ MHz}$	–	10	pF
$f_T$	transition frequency	$I_C = -10\text{mA}$ ; $V_{CE} = -2.0\text{ V}$ ; $f = 100\text{ MHz}$	250	–	MHz

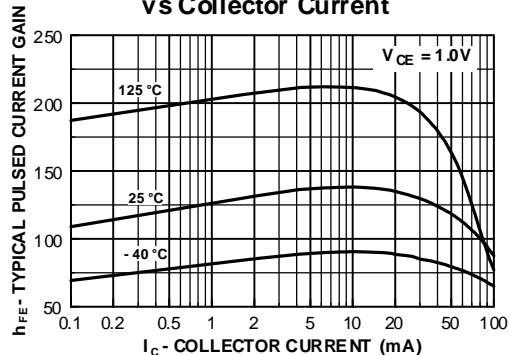
### Note

3. Pulse test:  $t_p \leq 300\text{ }\mu\text{s}$  ;  $\delta \leq 0.02$ .

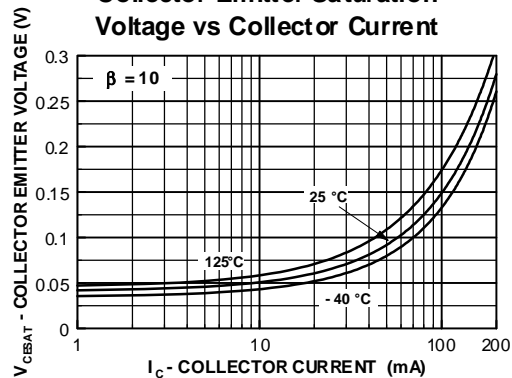
## RATING CHARACTERISTIC CURVES ( CHT4126GP )

### Typical Characteristics

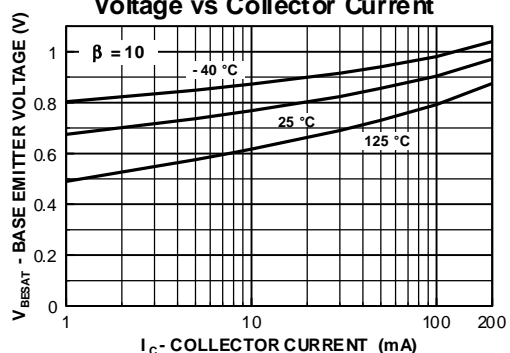
**Typical Pulsed Current Gain vs Collector Current**



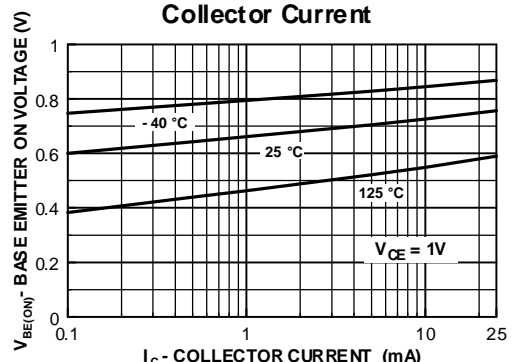
**Collector-Emitter Saturation Voltage vs Collector Current**



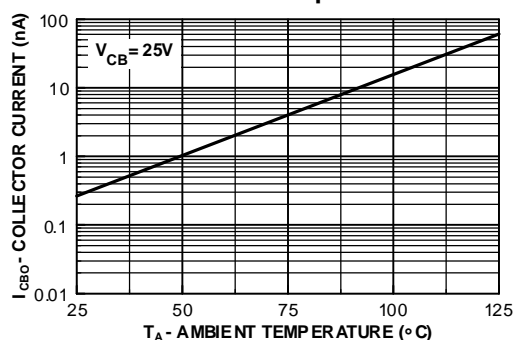
**Base-Emitter Saturation Voltage vs Collector Current**



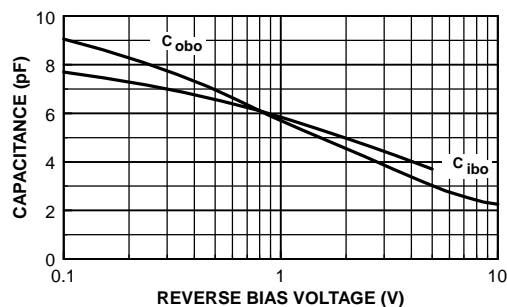
**Base Emitter ON Voltage vs Collector Current**



**Collector-Cutoff Current vs Ambient Temperature**



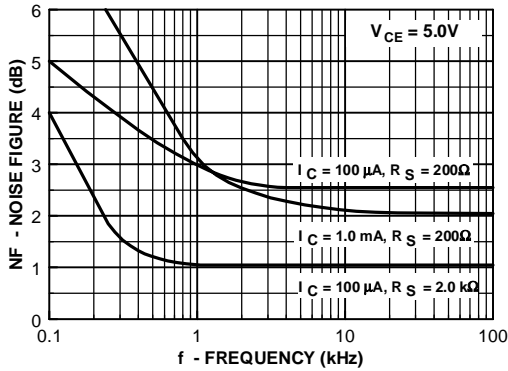
**Common-Base Open Circuit Input and Output Capacitance vs Reverse Bias Voltage**



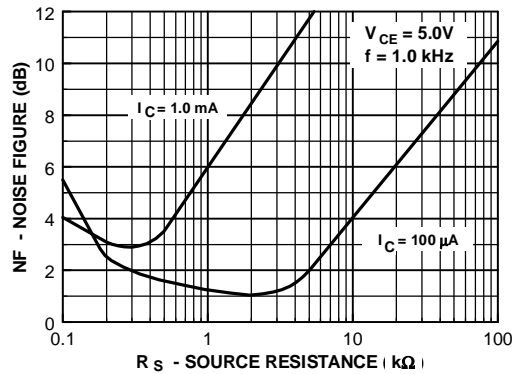
# RATING CHARACTERISTIC CURVES ( CHT4126GP )

## Typical Characteristics

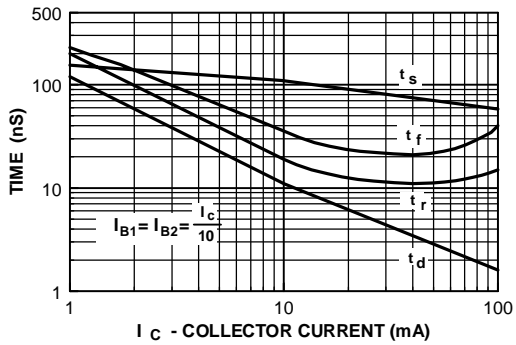
### Noise Figure vs Frequency



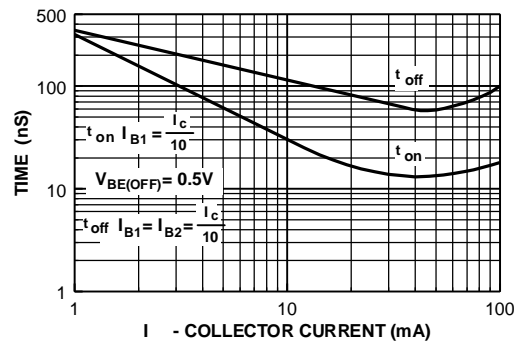
### Noise Figure vs Source Resistance



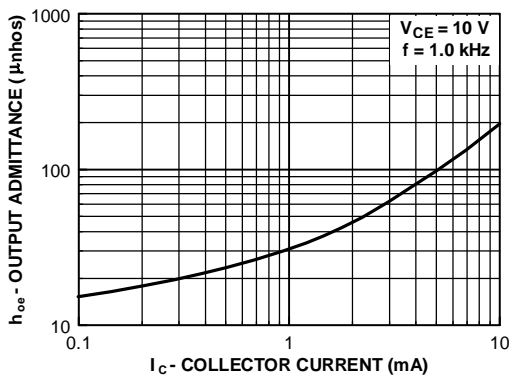
### Switching Times vs Collector Current



### Turn On and Turn Off Times vs Collector Current



### Output Admittance



### Current Gain

